

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM158AH	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM158AH, LM158AH)
LM158AH/NOPB	Active	Production	TO-99 (LMC) 8	500 OTHER	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM158AH, LM158AH)
LM158H	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM158H, LM158H)
LM158H/NOPB	Active	Production	TO-99 (LMC) 8	500 OTHER	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	(LM158H, LM158H)
LM158J	Active	Production	CDIP (NAB) 8	40 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158J
LM258H	Active	Production	TO-99 (LMC) 8	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-25 to 85	(LM258H, LM258H)
LM258H/NOPB	Active	Production	TO-99 (LMC) 8	500 TRAY NON-STD	Yes	Call TI	Level-1-NA-UNLIM	-25 to 85	(LM258H, LM258H)
LM2904ITP/NOPB	Active	Production	DSBGA (YPB) 8	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	A 09
LM2904ITP/NOPB.B	Active	Production	DSBGA (YPB) 8	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	A 09
LM2904ITPX/NOPB	Active	Production	DSBGA (YPB) 8	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	A 09
LM2904ITPX/NOPB.B	Active	Production	DSBGA (YPB) 8	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	A 09
LM2904M/NOPB	Active	Production	SOIC (D) 8	95 TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 85	LM 2904M
LM2904M/NOPB.B	Active	Production	SOIC (D) 8	95 TUBE	Yes	SN	Level-1-260C-UNLIM	-40 to 85	LM 2904M
LM2904MX/NOPB	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	LM 2904M
LM2904MX/NOPB.B	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	LM 2904M
LM2904N/NOPB	Active	Production	PDIP (P) 8	40 TUBE	Yes	NIPDAU	Level-1-NA-UNLIM	-40 to 85	LM 2904N
LM2904N/NOPB.B	Active	Production	PDIP (P) 8	40 TUBE	Yes	NIPDAU	Level-1-NA-UNLIM	-40 to 85	LM 2904N
LM358AM/NOPB	Active	Production	SOIC (D) 8	95 TUBE	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358AM
LM358AM/NOPB.B	Active	Production	SOIC (D) 8	95 TUBE	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358AM

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LM358AMX/NOPB	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358AM
LM358AMX/NOPB.B	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358AM
LM358AN/NOPB	Active	Production	PDIP (P) 8	40 TUBE	Yes	NIPDAU	Level-1-NA-UNLIM	0 to 70	LM 358AN
LM358AN/NOPB.B	Active	Production	PDIP (P) 8	40 TUBE	Yes	NIPDAU	Level-1-NA-UNLIM	0 to 70	LM 358AN
LM358H/NOPB	Active	Production	TO-99 (LMC) 8	500 TUBE	Yes	Call TI	Level-1-NA-UNLIM	0 to 70	(LM358H, LM358H)
LM358H/NOPB.B	Active	Production	TO-99 (LMC) 8	500 TUBE	Yes	Call TI	Level-1-NA-UNLIM	0 to 70	(LM358H, LM358H)
LM358M/NOPB	Active	Production	SOIC (D) 8	95 TUBE	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358M
LM358M/NOPB.B	Active	Production	SOIC (D) 8	95 TUBE	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358M
LM358MX/NOPB	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358M
LM358MX/NOPB.B	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	LM 358M
LM358N/NOPB	Active	Production	PDIP (P) 8	40 TUBE	Yes	NIPDAU	Level-1-NA-UNLIM	0 to 70	LM 358N
LM358N/NOPB.B	Active	Production	PDIP (P) 8	40 TUBE	Yes	NIPDAU	Level-1-NA-UNLIM	0 to 70	LM 358N
LM358TP/NOPB	Active	Production	DSBGA (YPB) 8	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	0 to 70	A 07
LM358TP/NOPB.B	Active	Production	DSBGA (YPB) 8	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	0 to 70	A 07
LM358TPX/NOPB	Active	Production	DSBGA (YPB) 8	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	0 to 70	A 07
LM358TPX/NOPB.B	Active	Production	DSBGA (YPB) 8	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	0 to 70	A 07

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LM2904-N :

- Automotive : [LM2904-Q1](#)
- Enhanced Product : [LM2904-EP](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications